

### **General Description**

The MAX9940 signal-line overvoltage protector for lowvoltage digital communication ports provides protection against high-voltage faults and ESD strikes. The MAX9940 is especially useful for sensitive communication protocols such as Maxim 1-Wire® that cannot afford standard means of fault protection, such as large series resistors or large line capacitances.

The MAX9940 operates from a single supply voltage of +2.2V to +5.5V and consumes only 13µA of quiescent supply current. The EXT port is protected up to 28V. The device features a reaction time of 60ns for fast action during fault conditions and operates over the -40°C to +125°C automotive temperature range.

### **Applications**

Notebook Computers Portable Devices Industrial Equipment

**Features** 

- **♦ 28V Protection on EXT**
- **♦ Extended ESD Protection** ±4kV IEC 61000-4 Contact on EXT
- ♦ +2.2V to +5.5V Supply Voltage Range
- ♦ 13µA Quiescent Supply Current
- ♦ 60ns Fault Reaction Time
- ♦ Small, 5-Pin SC70
- ♦ -40°C to +125°C Temperature Range

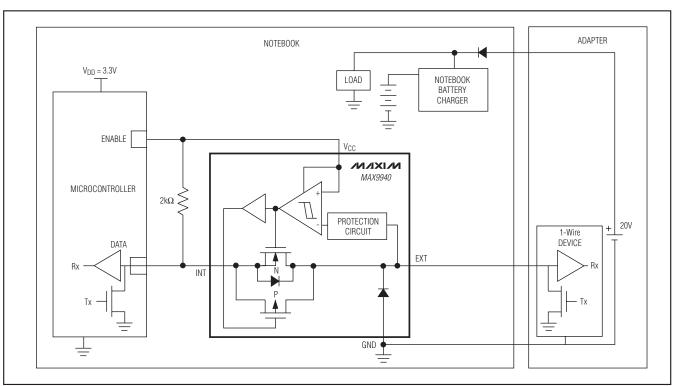
### **Ordering Information**

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX9940AXK+	-40°C to +125°C	5 SC70	ATC

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

1-Wire is a registered trademark of Maxim Integrated Products, Inc.

# **Block Diagram/Typical Application Circuit**



MIXIM

Maxim Integrated Products 1

#### ABSOLUTE MAXIMUM RATINGS

(All voltages with respect to GND.)	Continuous Power Dissipation (T <sub>A</sub> = +70°C)
V <sub>CC</sub> 0.3V to +6V	5-Pin SC70 (derate 3.1mW/°C above +70°C)245mW
INT0.3V to +6V	Operating Temperature Range40°C to +125°C
EXT0.3V to +30V	Junction Temperature+150°C
Continuous Input Current into Any Terminal±20mA	Storage Temperature Range65°C to +150°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +3.3V, R_{INT\_PULLUP} = 2k\Omega \text{ to } V_{DD}, V_{DD} = 3.3V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$  (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLY						
Power-Supply Voltage	Vcc		2.2		5.5	V
Quiescent Supply Current	Icc	V <sub>INT</sub> = 0		13	21	μΑ
DC CHARACTERISTICS						
INT Voltage Range	V <sub>INT</sub>		0		5.5	V
EXT Voltage Range	V <sub>EXT</sub>	(Note 2)	-0.7		+28	V
EXT Rising Threshold	V <sub>THR</sub>		V <sub>CC</sub> + 0.19	V <sub>CC</sub> + 0.26	V <sub>CC</sub> + 0.30	V
EXT Falling Threshold	V <sub>THF</sub>		V <sub>CC</sub> + 0.09	V <sub>CC</sub> + 0.13	V <sub>CC</sub> + 0.16	V
SWITCH CHARACTERISTICS	•		•			•
On-Resistance	Ron	0 < V <sub>EXT</sub> < V <sub>CC</sub> , I <sub>EXT</sub> = ±10mA		43.5	77.5	Ω
On-Capacitance	Con	Capacitance to GND		38		рF
INT Off-Capacitance	Coff	Capacitance to GND		27		рF
INT Normal Operation Leakage Current (to GND)		0 < V <sub>INT</sub> < V <sub>CC</sub> , V <sub>CC</sub> = 5.5V		3	4.2	μΑ
EXT Normal Operation Leakage Current (to GND)		0 < V <sub>EXT</sub> < V <sub>CC</sub> , V <sub>CC</sub> = 5.5V		3	5	μΑ
INT Fault Leakage Current		V <sub>INT</sub> = 3.3V, V <sub>EXT</sub> = 28V		2	10	nA
EXT Fault Leakage Current		V <sub>INT</sub> = 3.3V, V <sub>EXT</sub> = 28V		341	510	μA
INT Shutdown Leakage Current (to GND)		$V_{CC} = V_{DD} = 0$ , 2.2V < $V_{DD}$ < 5.5V, RINT_PULLUP = $2k\Omega$ to $V_{DD}$		38	70	μА
		$V_{CC} = V_{DD} = 0$		1		nA
AC CHARACTERISTICS						
Power-Up Delay Time	tpup			500		μs
Fault Reaction Time	torr	Fault, $V_{EXT} = 10V$ , $R_{INT\_PULLUP} = 200\Omega$		98	200	ns
i auit neaction mhe	tOFF	Fault, $V_{EXT} = 16V$ , $R_{INT\_PULLUP} = 200\Omega$		60		
Fault Recovery Time	ton	Fault removed, V <sub>EXT</sub> < V <sub>CC</sub> - 0.8V		271	375	ns

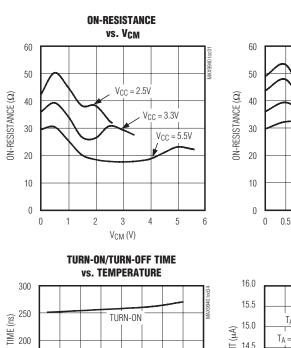
**Note 1:** All devices are 100% production tested at  $T_A = +25$ °C. Specifications over temperature limits are guaranteed by design.

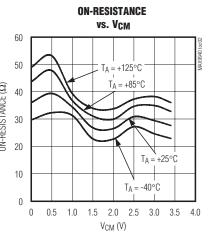
Note 2: Minimum EXT voltage of -0.7V is allowed only with a maximum drawn current of 20mA.

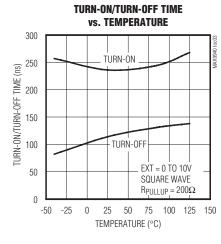


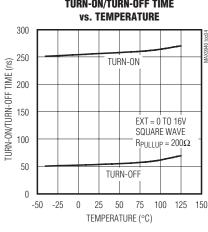
# Typical Operating Characteristics

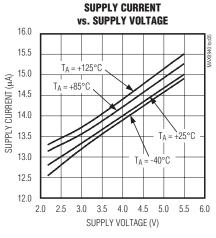
 $(V_{CC} = +3.3V, R_{INT} PULLUP = 2k\Omega \text{ to } V_{DD}, V_{DD} = 3.3V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$ 

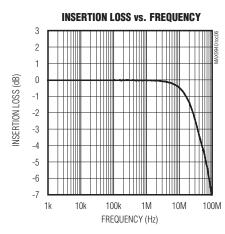


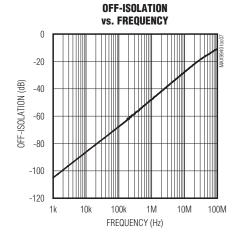


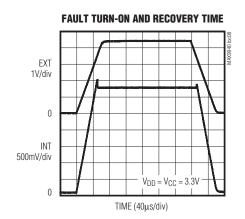








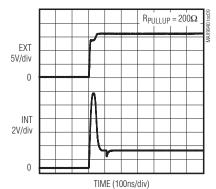




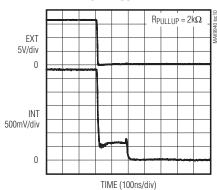
# \_Typical Operating Characteristics (continued)

 $(V_{CC} = +3.3V, R_{INT\_PULLUP} = 2k\Omega \text{ to } V_{DD}, V_{DD} = 3.3V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$ 

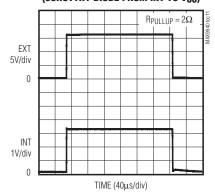




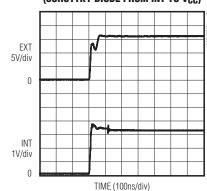
#### **FAULT RECOVERY TIME**



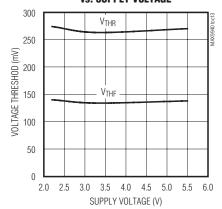
# FAULT TURN-ON AND RECOVERY TIME (SCHOTTKY DIODE FROM INT TO $V_{CC}$ )



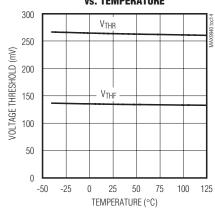
FAULT TURN-ON TIME (SCHOTTKY DIODE FROM INT TO V<sub>CC</sub>)



# V<sub>THR</sub> AND V<sub>THF</sub> vs. Supply voltage



# V<sub>THR</sub> AND V<sub>THF</sub> vs. Temperature



### **Pin Description**

PIN	NAME	FUNCTION	
1	Vcc	Power Supply. Can be connected to a microcontroller enable input.	
2	GND	Ground	
3	N.C.	No Connection. Not internally connected.	
4	INT	Microcontroller I/O Port. Connection to a microcontroller data port.	
5	EXT	External Connector Port. Connection to a 1-Wire device.	

### **Detailed Description**

The MAX9940 is a signal-line overvoltage protector for low-voltage devices that provides circuit protection from high-voltage faults and ESD strikes. The device provides protection in digital communication lines such as 1-Wire and I<sup>2</sup>C protocols where large series resistance and capacitances cannot be used to provide protection due to their impact on VIL/VIH levels and communication timing. The MAX9940 includes a series switch that connects INT to EXT. When a high-voltage fault condition occurs on EXT, the MAX9940 quickly shuts off the series switch and isolates the low-voltage device from the fault condition. In addition to providing DC fault isolation, the MAX9940 also provides up to ±4kV IEC 61000-4 contact ESD protection on EXT. The MAX9940 is ideal for circuits that require low-voltage devices that communicate to the outside world over connector ports that can expose them to hazardous high-voltage DC faults and ESD strikes.

#### Series Switch

The MAX9940 features a series switch to connect a low-voltage device such as a microcontroller to an external communication device such as a 1-Wire or I<sup>2</sup>C slave. The internal switch is turned off when disabled or if a fault condition exists, isolating the microcontroller from any possible damage. The nominal switch resistance is  $38\Omega$  (typ). The series switch is composed of parallel DMOS and HV-pMOS devices as shown in the

Block Diagram/Typical Application Circuit. The series switch cell contains circuitry that ensures the pMOS device turns off properly when the voltage at EXT exceeds the supply voltage. The switch can withstand a maximum voltage of 28V at EXT.

#### **Comparator**

The MAX9940 features a low-power, high-speed comparator that is used to turn off the series switch if a high-voltage condition is detected on EXT. The nominal hysteresis of the comparator is 128mV (typical). Fault voltages on EXT that are slightly above VCC trigger the comparator to quickly isolate INT and EXT channels from each other. In this mode, the MAX9940 is able to withstand 28V on EXT. Negative voltages on EXT are allowed as long as they are current-limited to less than 20mA.

### **Typical Application Circuits**

The innovative design of the MAX9940 allows it to with stand large DC voltages up to 28V at INT and EXT even when  $V_{\rm CC}$  is 0. This allows application-specific powersaving and fault-protection schemes to be implemented.

Figures 1 and 2 show two methods of powering the MAX9940 from an ENABLE digital output port of the microcontroller. Figure 3 shows the conventional method of operating the MAX9940 with both pullup resistor for digital communication on DATA (RP) and VCC being connected directly to VDD of the microcontroller.

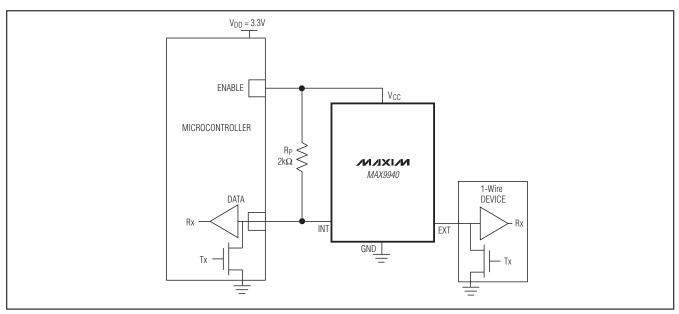


Figure 1. Recommended Scheme for Battery-Operated Devices that Need to Shut Down the MAX9940 and Prevent Power Draw During Short to GND Faults

In all three schemes, the MAX9940 protects the microcontroller from both DC fault voltages above V<sub>CC</sub> and ESD strikes on EXT. The difference in the three schemes lies in the impact on power consumption in battery-operated devices during normal and short to GND fault conditions.

Figure 1 shows a recommended configuration for battery-operated devices that need to conserve power both on a continuous basis as well as during short to GND fault conditions. In this scheme, the ENABLE port of a microcontroller supplies the quiescent current for the MAX9940 as well as that required for digital communication (i.e., Rp pullup resistor). By forcing a 0 on the ENABLE digital output port of the microcontroller, the MAX9940 is in a zero-power shutdown mode, while also preventing any power drain to occur in the event of a short to GND fault on EXT. As stated earlier, EXT maintains the ability to withstand DC voltages up to 28V even when  $V_{\rm CC} = 0$ .

In Figure 2, the ENABLE port of a microcontroller powers the MAX9940. The low 13µA operating current allows standard digital I/O ports to easily supply the

operating current of the MAX9940 without any substantial voltage drop (VOH  $\approx$  VDD). By forcing a 0 on the ENABLE port of the microcontroller, the MAX9940 can be put into a zero-power mode, thus conserving battery power. It should be noted that there is no internal ESD diode from INT to VCC. This allows the voltage at INT to stay at VDD even though VCC = 0, thus drawing no current from RP or the battery. However, an internal diode does exist from INT to EXT, and therefore, in the event of a short to GND fault on EXT, current is drawn through RP, causing a power drain from VDD, and can potentially reduce battery life.

In Figure 3, VDD powers the MAX9940 directly, and consumes quiescent current on a continuous basis. In this mode, the internal FET between INT and EXT is kept on as long as the voltage on EXT is below VCC. As a result, in the event of a short to GND fault on EXT, current is drawn through RP, causing a power drain from VDD and potentially reducing battery life.

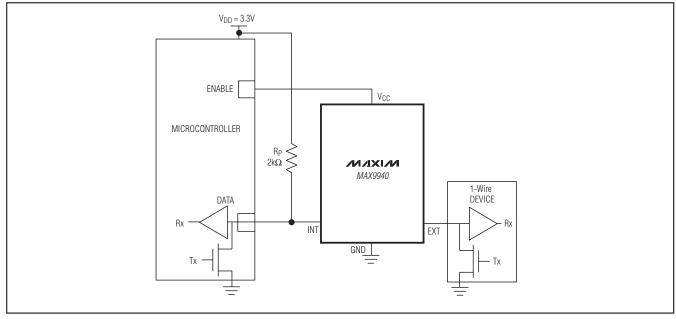


Figure 2. Recommended Scheme for Applications that Require the MAX9940 to be Put into Shutdown

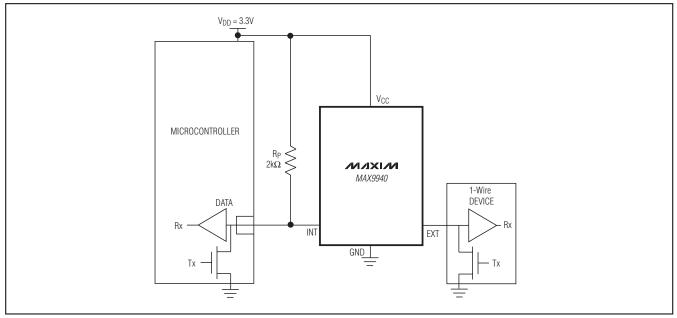
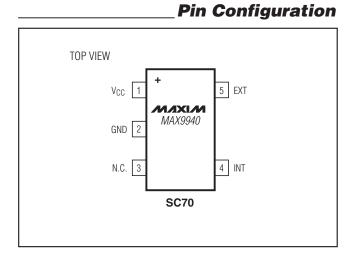


Figure 3. Recommended Operating Circuit for Nonbattery-Operated Applications



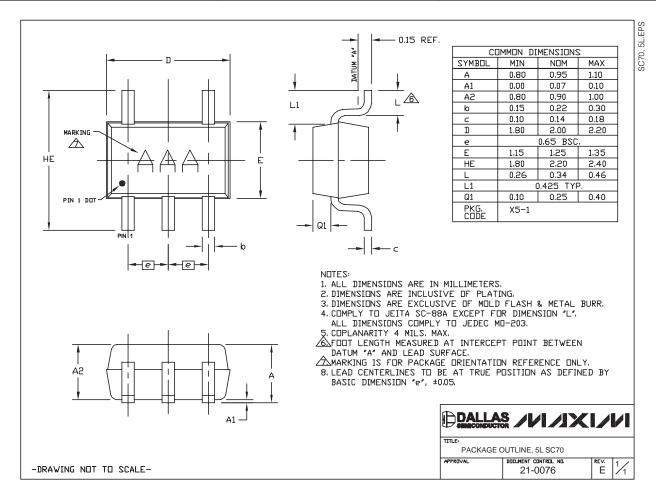
**Chip Information** 

PROCESS: BICMOS

### Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
5 SC70	X5-1	<u>21-0076</u>



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